

I C T INC

INC

T-46-19-07

PA7024 PEEL[™]Array **CMOS Programmable Electrically Erasable Logic Array**

Features

User-Configurable High Density Logic Array

- Create multi-level I/O-buried logic circuits
- Over 80 sum-of-products functions
- 20 I/Os, 2 Input/system-clocks 24 pin DIP, 28 pin PLCC packaging

CMOS EE-Technology

- Low power, 140mA at 25MHz
 Reprogrammable in plastic package
- Low risk inventory, superior factory testing

High Performance

- Wide-gate functions in single level delays
- tpd = 13ns/20ns (internal/external)
- fmax = from 41.6MHz/43.5MHz/58.8MHz

Flexible Architecture

- Input registers and latches
- I/O buried D, T and JK registers with independent clock, preset and reset
- Separate output enables per I/O

encoders, muxs, comparators, shifters, counters, state machines, etc.

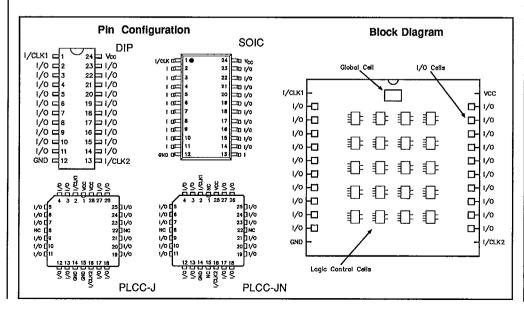
Simplified Development Methodology

- Predictable symmetrical timing, no routing Design support with PLACE™ Software
- and PEEL Development System from ICT
- ABEL 4.0 support

General Description

The PA7024 is a user-configurable high-density Programmable Electrically Erasable Logic (PEEL) Array for creating multi-level, I/O-buried, logic circuits. Designed in ICT's advanced 1-micron CMOS EE-technology, the PA7024 offers low power consumption, high speed performance, and reprogrammability in a plastic package allowing superior factory testing and a low risk re-usable inventory. The PA7024's wide-gate architecture can implement complex combinatorial and sequential functions within single-level delays as fast as 13nS (internal) and at clock rates greater than 50MHz.

It's flexible architecture offers: input reg/latches per I/O, buried D, T, or JK registers with independent clock, preset and reset, and separate output enables. This versatility makes the PA7024 ideal for integrating SSI/MSI, multiple PLDs and customizing random logic, decoders, muxs, comparators, shifters, counters, state machines, etc. Extensive signal interconnectivity makes all timing paths symmetrical, simplifying design with predictable performance and the elimination of gate-arraylike routing. Complete development and programming support is provided by ICT's PLACE Software and PEEL Development System.





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Absolute Maximum Ratings

Exposure to absolute maximum ratings over extended periods of time may affect device reliability. Exceeding absolute maximum ratings may cause permanent damage

Symbol	Parameter	Conditions	Rating	Unit
Vcc	Supply Voltage	Relative to GND	- 0.5 to + 7.0	V
Vı, Vo	Voltage Applied to Any Pin	Relative to GND ¹	- 0.5 to Vcc + 0.6	٧
lo	Output Current	Per pin (IOL, IOH)	± 25	mA
TsT	Storage Temperature		- 65 to + 150	.c
TLT	Lead Temperature	(Soldering 10 seconds)	+ 300	.c

Operating Ranges

Symbol	Parameter	Conditions	Min	Max	Unit
Vcc	Supply Voltage	Commercial ²	4.75	5.25	V
TA	Ambient Temperature	Commercial ²	0	+ 70	.c
TR	Clock Rise Time	(Note 3)		250	ns
TF	Clock Fall Time	(Note 3)		250	ns
TRVCC	Vcc Rise Time	(Note 3)		250	ms

D.C. Electrical Characteristics Over the operating range

Symbol	Parameter	Conditions	Min	Max	Unit
Vон	Output HIGH Voltage - TTL	Vcc = Min, IoH = -4.0mA	2.4		٧
Vонс	Output HIGH Voltage-CMOS	Vcc = Min, loн = -10μA	Vcc - 0.1		٧
Vol	Output LOW Voltage - TTL	Vcc = Min, loL = 16mA		0.5	٧
Volc	Output LOW Voltage-CMOS	Vcc = Min, loL = 10μA		0.1	٧
ViH	Input HIGH Level		2.0	Vcc + 0.3	٧
VIL	Input LOW Level		- 0.3	0.8	٧
lıL.	Input Leakage Current	Vcc = Max, GND ≤ Vin ≤ Vcc		±10	μА
loz	Output Leakage Current	VO = High-Z, GND ≤ Vo≤ Vcc		±10	μА
Isc	Output Short Circuit Current ⁵	Vcc=5V,VO=0.5V, TA=25°C	- 30	- 120	mA
lcc	Vcc Current	V _{IN} = 0V or 3V ^{4, 12} f = 25MHz All outputs disabled		140	mA
Cin	Input Capacitance 6	Ta=25°C, Vcc = 5.0V		6	pF
Соит	Output Capacitance ⁶	@ f = 1MHz		12	рF



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A.C. Electrical Characteristics Combinatorial

Over operating conditions

Symbol	Parameters ^{7, 13}	PA7	PA7024-1		PA7024-2	
		Min	Max	Min	Max	Units
tpDI	Propagation delay Internal (tAL+ tLC)		13		17	nS
tPDX	Propagation delay External (t _{IA} + t _{AL} + t _{LC} + t _{LO})		20		25	nS
tia	Input or I/O pin to Array input		2		2	nS
taL	Array input to LCC		12		16	nS
tLC	LCC input to LCC output ¹¹		1	-	1	nS
tLO	LCC output to output pin		5		6	nS
top, toe	Output Disable, Enable from LCC output ⁸		5		6	nS
tox	Output Disable, Enable from input pin ⁸		20		25	nS

Notes:

- $\begin{array}{ll} \mbox{Minimum DC input is } -0.5\mbox{V, however inputs may undershoot to} -2.0\mbox{V for periods less than 20nS.} \\ \mbox{Contact ICT for other operating ranges} \end{array}$ 1.
- Test points for Clock and Vcc in tr, tr, tcl, tch, and treset are referenced at 10% and 90% levels.
- I/O pins are 0V or 3V.
- Test one output at a time for a duration of less than 1 sec.
- Capacitances are tested on a sample basis.
- Test conditions assume: signal transition times of 5ns or less from the 10% and 90% points, timing reference levels of 1.5V (unless otherwise specified).
- toe is measured from input transition to VREF ± 0.1V (See test loads at end of section 5 for VREF value). tOD is measured from input transition to VOH 0.1V or VOL +
- "System-clock" refers to pin 1 or pin 13 high speed clocks
- 10. For T or JK registers in toggle (divide by 2) operation only
- 11. For combinatorial and async-clock to LCC output delay
- 12. ICC for a typical application: This parameter is tested with the device programmed as a 10-bit D type Counter.
- 13. Test loads are specified at the end of section 3 in this data

- 14. "Async, clock" refers to the clock from the Sum term (OR qate)
- 15. The "LCC" term indicates that the timing parameter is applied to the LCC register.
 - The "IOC" term indicates that the timing parameter is ap-
 - plied to the IOC register.

 The "LCC/IOC" term indicates that the timing parameter is applied to both the LCC and IOC registers.
- 16. The term "Input" without any reference to another term refers to an (external) input pin.
- 17. The parameter tsp indicates that the PCLK signal to the IOC register is always slower than the data from the pin or input by the absolute value of (tsk - tek - tra). This means that no set-up time for the data from the pin or input is required, i.e. the external data and clock can be sent to the device simultaneously. Additionally, the data from the pin must remain stable for ther time, i.e. to wait for the PCLK signal to arrive at the IOC register.



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A.C. Electrical Characteristics Sequential Over operating conditions

	Parameters 7, 13	PA7024-1		PA7024-2		I lmb-
Symbol	Parameters 7, 13		Max	Min	Max	Units
tsci	Internal set-up to system-clock ⁹ - LCC ¹⁵ (I _{AL+} tsk+ tlc - tck)	10		15		nS
tscx	Input 16 (Ext.) set-up to system-clock,-LCC(tiA+ tsci))	12		17		nS
tcoı	System-clock to Array Int LCC/IOC15 (tck + tLo)		7		8	nS
tcox	System-clock to Output Ext LCC (tco+ tLo)		12		13	nS
tHX	Input hold time from system clock - LCC	0		0		nS
tsĸ	LCC input set-up to async. clock 14 - LCC	3		4		nS
thĸ	LCC input hold time from async. clock - LCC	4		4		nS
tsı	Input set-up to system clock - IOC15 (tsк - tcк)	0		0		nS
tHI	Input hold time from system clock - IOC (tck - tsk)	3		3	İ	nS
tpK	Array input to IOC PCLK clock		7		9	nS
tspi	Input set-up to PCLK clock - IOC (tsk - tpk - tia) 17	0		0		n\$
thPI	Input hold time from PCLK clock -IOC (tpk+tia-tsk) 17	6		7		nS
tcĸ	System-clock delay to LCC and IOC		6		7	nS
tcw	System-clock low or high pulse width	7		8		nS
fMAX1	Max system-clock frequency Int/Int 1/(Isci + tcoi)		58.8		43.5	MHz
fMAX2	Max system-clock frequency Ext/Int 1/(tscx + tcoi)		52.6		40.0	MHz
fмахз	Max system-clock frequency Int/Ext 1/(tsci + tcox)		45.7		35.7	MHz
fMAX4	Max system-clock frequency Ext/Ext 1/(tscx+ tcox)		41.6		33.3	MHz
fTGL	Max system-clock toggle frequency 1/(tcw + tcw) 10		71.4		62.5	MHz
tpR	LCC Preset/Reset to LCC output		1		2	nS
tst	Input to Global Cell preset/reset (tiA + tAL + tPR)	,	15		20	nS
taw	Asynch. preset/reset pulse width	8		8		nS
trr	Input to LCC Reg-Type (RT)		8		10	nS
trtv	LCC Reg-Type to LCC output register change		1		2	nS
trtc	Input to Global Cell register-type change (trt + trtv)		9		12	nS
trw	Asynch. Reg-Type pulse width	10		10		nS
TRESET	Power - on reset time for registers in clear state ³		5		5	μS